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Kind regards,

Team Nexperia



# PMBD7000 Double high-speed switching diode Rev. 4 — 16 September 2010

**Product data sheet** 

## 1. Product profile

### 1.1 General description

The PMBD7000 consists of two high-speed switching diodes connected in series, fabricated in planar technology, and encapsulated in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

#### 1.2 Features and benefits

- High switching speed:  $t_{rr} \le 4$  ns
- Repetitive peak forward current:  $I_{FRM} \le 450 \text{ mA}$
- Small SMD plastic package

### **1.3 Applications**

- High-speed switching
- General-purpose switching

#### 1.4 Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
I <sub>R</sub>	reverse current	V <sub>R</sub> = 100 V	-	-	0.5	μA
V <sub>R</sub>	reverse voltage		-	-	100	V
t <sub>rr</sub>	reverse recovery time		<u>[1]</u> -	-	4	ns

[1] When switched from  $I_F$  = 10 mA to  $I_R$  = 10 mA;  $R_L$  = 100  $\Omega;$  measured at  $I_R$  = 1 mA.



- Reverse voltage:  $V_R \le 100 V$
- Repetitive peak reverse voltage: V<sub>RRM</sub> ≤ 100 V
- AEC-Q101 qualified

#### Double high-speed switching diode

#### **Pinning information** 2.

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	anode (diode 1)		_
2	cathode (diode 2)		3
3	cathode (diode 1), anode (diode 2)	1 2	

*006aaa763* 

#### 3. **Ordering information**

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PMBD7000	-	plastic surface-mounted package; 3 leads	SOT23			

#### Marking 4.

king code <sup>[1]</sup>
ł

[1] \* = -: made in Hong Kong

- \* = p: made in Hong Kong \* = t: made in Malaysia
- \* = W: made in China

#### Double high-speed switching diode

### 5. Limiting values

Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
V <sub>RRM</sub>	repetitive peak reverse voltage		-	100	V
V <sub>R</sub>	reverse voltage		-	100	V
l <sub>F</sub>	forward current		[1] -	215	mA
			[2] _	125	mA
I <sub>FRM</sub>	repetitive peak forward current		-	450	mA
I <sub>FSM</sub>	non-repetitive peak forward current	square wave	[3]		
		t <sub>p</sub> = 1 μs	-	4	А
		t <sub>p</sub> = 1 ms	-	1	А
		t <sub>p</sub> = 1 s	-	0.5	А
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1][4]</u> _	250	mW
Per device	)				
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Single diode loaded.

[2] Double diode loaded.

[3]  $T_j = 25 \ ^\circ C$  prior to surge.

[4] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

# 6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1][2]</u> _	-	500	K/W
R <sub>th(j-t)</sub>	thermal resistance from junction to tie-point		-	-	360	K/W

[1] Single diode loaded.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

#### Double high-speed switching diode

### 7. Characteristics

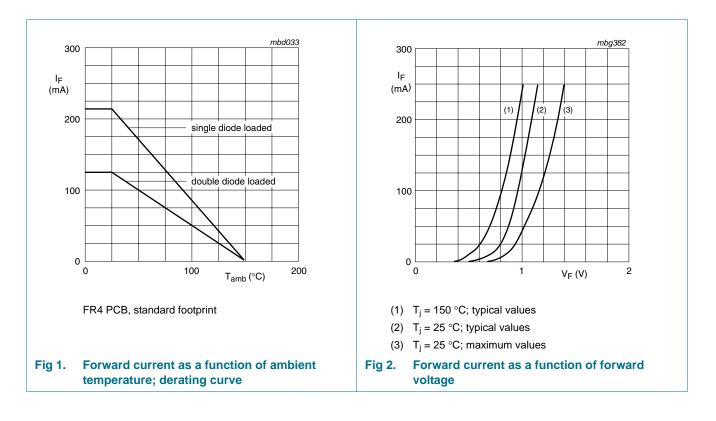
Table 7.Characteristics

$T_j = 25 \ ^{\circ}C$ unless otherwise specified.
--

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode	e					
V <sub>F</sub> forward voltage	forward voltage	I <sub>F</sub> = 1 mA	-	550	700	mV
		I <sub>F</sub> = 10 mA	-	670	820	mV
		I <sub>F</sub> = 50 mA	-	-	1	V
		I <sub>F</sub> = 100 mA	-	0.75	1.1	V
		I <sub>F</sub> = 150 mA	-	-	1.25	V
I <sub>R</sub> reverse current	reverse current	V <sub>R</sub> = 50 V	-	-	300	nA
		V <sub>R</sub> = 100 V	-	-	500	nA
		$V_R = 50 \text{ V}; \text{ T}_j = 150 ^{\circ}\text{C}$	-	-	100	μΑ
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 0 V	-	-	1.5	pF
t <sub>rr</sub>	reverse recovery time		<u>[1]</u> _	-	4	ns
V <sub>FR</sub>	forward recovery voltage	)	[2] _	-	1.75	V

[1] When switched from I<sub>F</sub> = 10 mA to I<sub>R</sub> = 10 mA; R<sub>L</sub> = 100  $\Omega$ ; measured at I<sub>R</sub> = 1 mA.

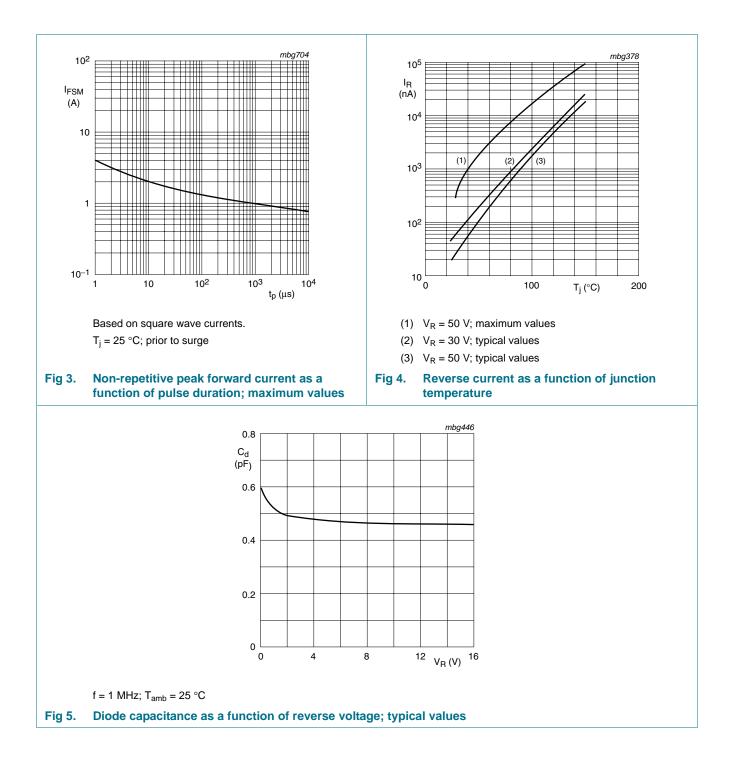
[2] When switched from  $I_F$  = 10 mA;  $t_r$  = 20 ns.



#### **NXP Semiconductors**

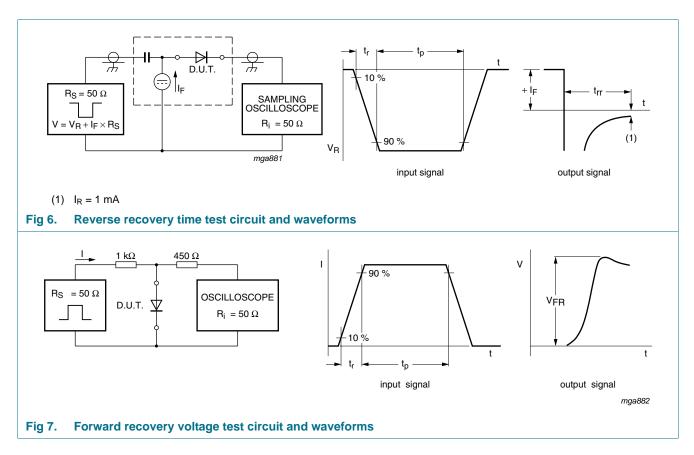
# **PMBD7000**

#### Double high-speed switching diode



#### Double high-speed switching diode

## 8. Test information



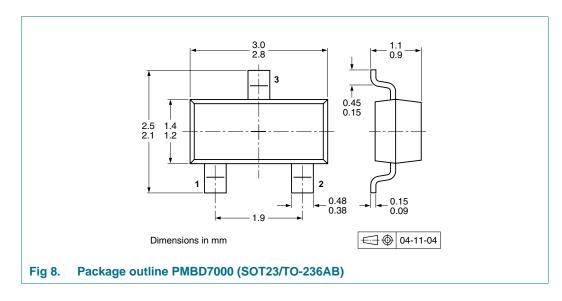
#### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

PMBD7000 Product data sheet

#### Double high-speed switching diode

### 9. Package outline



# **10. Packing information**

#### Table 8. Packing methods

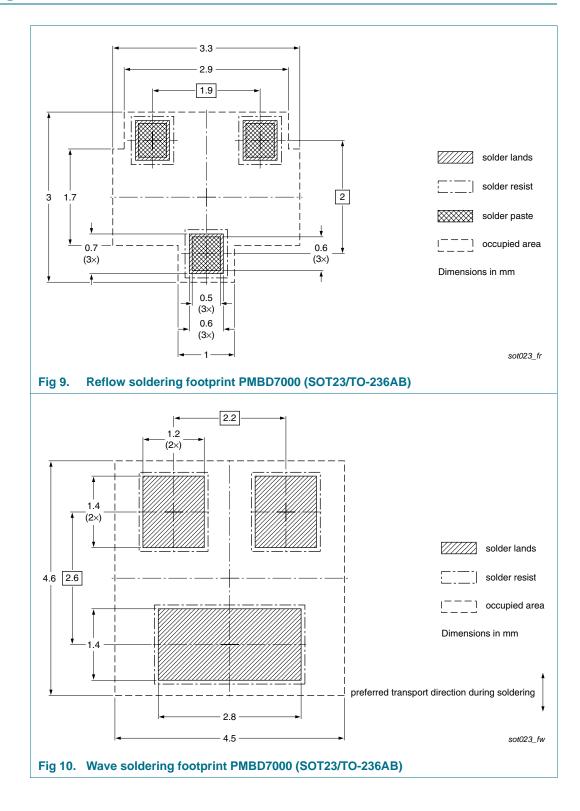
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing	guantity
			3000	10000
PMBD7000	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

#### Double high-speed switching diode

### 11. Soldering



PMBD7000

### Double high-speed switching diode

# 12. Revision history

Table 9.Revision h	history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
PMBD7000 v.4	20100916	Product data sheet	-	PMBD7000_3		
Modifications:		t of this data sheet has been of NXP Semiconductors.	redesigned to comply v	vith the new identity		
	<ul> <li>Legal texts</li> </ul>	have been adapted to the n	new company name whe	ere appropriate.		
	<ul> <li><u>Table 4 "Marking codes"</u>: updated</li> </ul>					
	<ul> <li><u>Table 7 "Characteristics</u>": corrected V<sub>F</sub> unit for condition I<sub>F</sub> = 150 mA</li> </ul>					
	• Figure 2: updated					
	<ul> <li>Section 8 "Test information": figure title of Figure 6 amended</li> </ul>					
	<ul> <li>Section 8.1 "Quality information": added</li> </ul>					
	Section 13	"Legal information": updated	d			
PMBD7000_3	19990511	Product specification	-	PMBD7000_2		
PMBD7000_2	19960918	Product specification	-	PMBD7000_1		
PMBD7000 1	19960419	Product specification	-	-		

### 13. Legal information

#### 13.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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#### Double high-speed switching diode

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#### Double high-speed switching diode

### **15. Contents**

1	Product profile 1
1.1	General description 1
1.2	Features and benefits 1
1.3	Applications 1
1.4	Quick reference data 1
2	Pinning information 2
3	Ordering information 2
4	Marking 2
5	Limiting values 3
6	Thermal characteristics 3
7	Characteristics 4
8	Test information 6
8.1	Quality information 6
9	Package outline 7
10	Packing information 7
11	Soldering 8
12	Revision history 9
13	Legal information 10
13.1	Data sheet status 10
13.2	Definitions 10
13.3	Disclaimers
13.4	Trademarks 11
14	Contact information 11
15	Contents 12

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